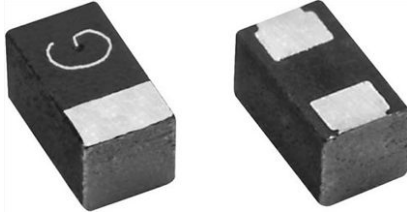


Solid Tantalum Chip Capacitors MICROTAN[®] Low ESR, Leadframeless Molded


FEATURES

- Lead (Pb)-free face-down terminations
- Mounting: Surface mount
- 8 mm tape and reel packaging available per EIA-481 and reeling per IEC 60286-3 7" [178 mm] standard
- Low ESR
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
GREEN
(5-2008)

PERFORMANCE CHARACTERISTICS

Operating Temperature: - 55 °C to + 125 °C
(above 85 °C, voltage derating is required)

Capacitance Range: 1 μF to 220 μF

Capacitance Tolerance: ± 20 % standard, ± 10 % available

Voltage Range: 4 V_{DC} to 16 V_{DC}

ORDERING INFORMATION						
TR8 TYPE	M CASE CODE	106 CAPACITANCE	M CAPACITANCE TOLERANCE	6R3 DC VOLTAGE RATING AT + 85 °C	C TERMINATION	2000 ESR
	See Ratings and Case Codes table	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	K = ± 10 % M = ± 20 %	This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V).	C = 100 % tin 7" [178 mm] reel A = Gold/7" [178 mm] reel	Maximum 100 kHz ESR in (mΩ) See note below.

Note

- We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size. Voltage substitutions will be marked with the higher voltage rating. Low ESR solid tantalum chip capacitors allow delta ESR of 1.25 times the datasheet limit after mounting.

DIMENSIONS in inches [millimeters]						
CASE CODE	L	W	H (MAX.)	P1	P2 (REF.)	C
M	0.063 ± 0.008 [1.60 ± 0.2]	0.033 ± 0.008 [0.85 ± 0.2]	0.035 [0.9]	0.020 ± 0.004 [0.50 ± 0.1]	0.024 [0.60]	0.024 ± 0.004 [0.60 ± 0.1]
R	0.081 ± 0.006 [2.06 ± 0.15]	0.053 ± 0.006 [1.35 ± 0.15]	0.062 [1.57]	0.020 ± 0.004 [0.51 ± 0.1]	0.043 [1.10]	0.035 ± 0.004 [0.90 ± 0.1]
P	0.094 ± 0.004 [2.4 ± 0.1]	0.057 ± 0.004 [1.45 ± 0.1]	0.047 [1.2]	0.020 ± 0.004 [0.50 ± 0.1]	0.057 [1.40]	0.035 ± 0.004 [0.90 ± 0.1]
Q	0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.039 [1.0]	0.031 ± 0.004 [0.80 ± 0.1]	0.063 [1.60]	0.047 ± 0.004 [1.20 ± 0.1]
A	0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.071 [1.8]	0.031 ± 0.004 [0.80 ± 0.1]	0.063 [1.60]	0.047 ± 0.004 [1.20 ± 0.1]

RATINGS AND CASE CODES						
μF	2.5 V	4 V	6.3 V	10 V	16 V	25 V
1.0					M	
2.2				M	M	
4.7				M	M	
10			M	M	R	A
15			M	M		
22			M			
33		M	M	P		
47		M		P		
100		P	P/A			
220	P	P/Q				

MARKING			
<p>M-Case</p>		<p>P-, R-Case</p>	
		<p>A-, Q-Case</p>	
VOLTAGE CODE		CAPACITANCE CODE	
V	CODE	CAP, μF	CODE
2.5	e	10	α
4.0	G	33	n
6.3	J	47	s
10	A	68	w
16	C	100	\bar{A}
20	D	150	\bar{E}
25	E	220	\bar{J}



STANDARD RATINGS						
CAPACITANCE (μF)	CASE CODE	PART NUMBER	MAX. DCL AT + 25 °C (μA)	MAX. DF AT + 25 °C (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I_{RMS} (A)
2.5 V_{DC} AT + 85 °C; 1.6 V_{DC} AT + 125 °C						
220	P	TR8P227M2R5C1500	11.0	30	1.50	0.129
4 V_{DC} AT + 85 °C; 2.7 V_{DC} AT + 125 °C						
33	M	TR8M336M004C1500	2.6	30	1.50	0.129
47	M	TR8M476M004C1500	3.8	40	1.50	0.129
100	P	TR8P107M004C1500	4.0	30	1.50	0.173
220	P	TR8P227(1)004C1000	17.6	30	1.00	0.212
220	Q	TR8Q227M004C1200	88.0	80	1.20	0.214
6.3 V_{DC} AT + 85 °C; 4 V_{DC} AT + 125 °C						
10	M	TR8M106(1)6R3C2000	0.6	8	2.00	0.112
15	M	TR8M156M6R3C3000	0.9	20	3.00	0.091
22	M	TR8M226M6R3C1500	2.8	20	1.50	0.129
33	M	TR8M336M6R3C1500	4.2	30	1.50	0.129
100	P	TR8P107M6R3C1500	6.3	30	1.50	0.173
100	A	TR8A107M6R3C0500	6.3	20	0.50	0.390
10 V_{DC} AT + 85 °C; 7 V_{DC} AT + 125 °C						
2.2	M	TR8M225M010C4000	0.5	10	4.00	0.079
4.7	M	TR8M475M010C3000	0.5	6	3.00	0.079
10	M	TR8M106M010C2000	1.0	20	2.00	0.112
15	M	TR8M156(1)010C3000	1.5	30	3.00	0.091
33	P	TR8P336M010C2500	3.3	20	2.50	0.134
47	P	TR8P476M010C0800	4.7	22	0.80	0.237
47	P	TR8P476M010C1000	4.7	22	1.00	0.212
16 V_{DC} AT + 85 °C; 10 V_{DC} AT + 125 °C						
1.0	M	TR8M105(1)016C9500	0.5	6	9.50	0.050
2.2	M	TR8M225M016C4000	0.5	10	4.00	0.079
4.7	M	TR8M475M016C4000	0.8	8	4.00	0.079
4.7	M	TR8M475M016C9000	0.8	8	9.00	0.053
10	R	TR8R106M016C5000	1.6	8	5.00	0.095
25 V_{DC} AT + 85 °C; 17 V_{DC} AT + 125 °C						
10	A	TR8A106M025C2500	2.5	10	2.50	0.173

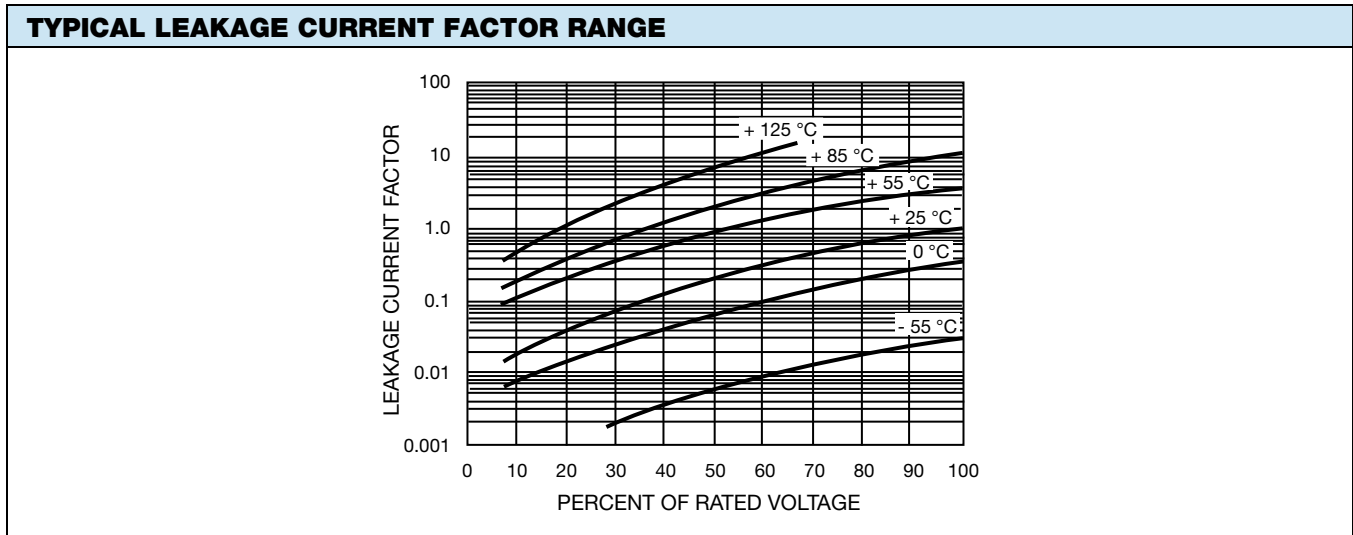
Note

- Part number definition:
 - (1) Tolerance: For 10 % tolerance, specify "K"; for 20 % tolerance, change to "M"



CAPACITORS PERFORMANCE CHARACTERISTICS

ELECTRICAL PERFORMANCE CHARACTERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS			
Category Temperature Range	- 55 °C to + 85 °C (to + 125 °C with voltage derating)			
Capacitance Tolerance	± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz			
Dissipation Factor (at 120 Hz)	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz.			
ESR (100 kHz)	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz.			
Leakage Current	After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 kΩ resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings table. Note that the leakage current varies with temperature and applied voltage. See graph below for the appropriate adjustment factor.			
Reverse Voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at + 25 °C 5 % of the DC rating at + 85 °C 1 % of the DC rating at + 125 °C Vishay does not recommend intentional or repetitive application of reverse voltage			
Temperature Derating	If capacitors are to be used at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at + 25 °C 0.9 at + 85 °C 0.4 at + 125 °C			
Operating Temperature	+ 85 °C RATING		+ 125 °C RATING	
	RATED VOLTAGE (V)	SURGE VOLTAGE (V)	RATED VOLTAGE (V)	SURGE VOLTAGE (V)
	2.5	3.3	1.7	2.2
	4.0	5.2	2.7	3.4
	6.3	8.0	4.0	5.0
	10	13	7.0	8.0
	16	20	10	12
	20	26	13	16
	25	32	17	20
	35	46	23	28
50	65	33	40	



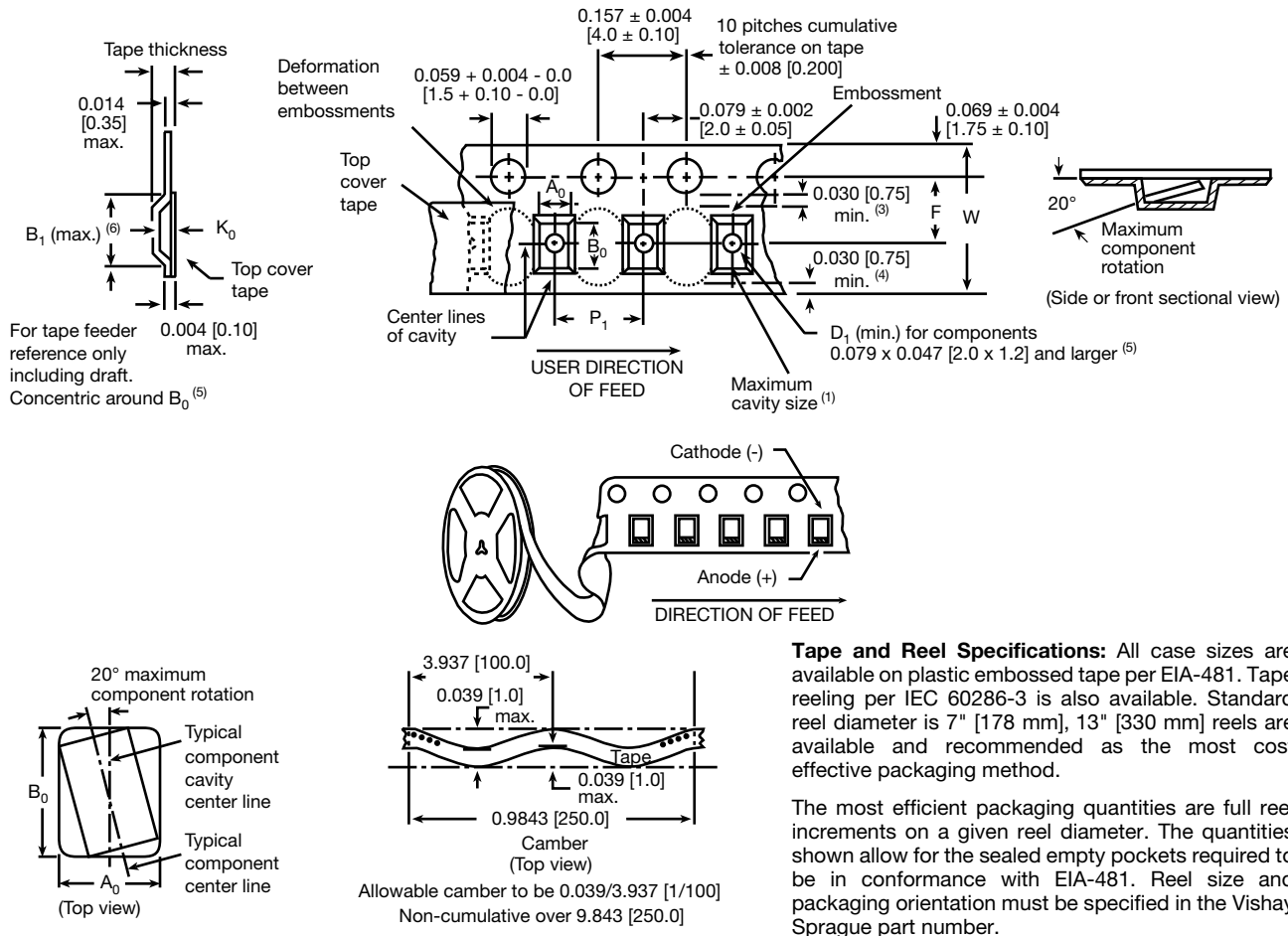
Notes

- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At + 85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table.



ENVIRONMENTAL PERFORMANCE CHARACTERISTICS		
ITEM	CONDITION	POST TEST PERFORMANCE
Life Test at + 85 °C	1000 h application of rated voltage at 85 °C with a 3 Ω series resistance, MIL-STD-202 method 108A	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial
Humidity Test	At 40 °C/90 % RH 500 h, no voltage applied. MIL-STD-202 method 103B	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial
Thermal Shock	At - 55 °C/+ 125 °C, 30 min each, for 5 cycles. MIL-STD-202 method 107G	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial

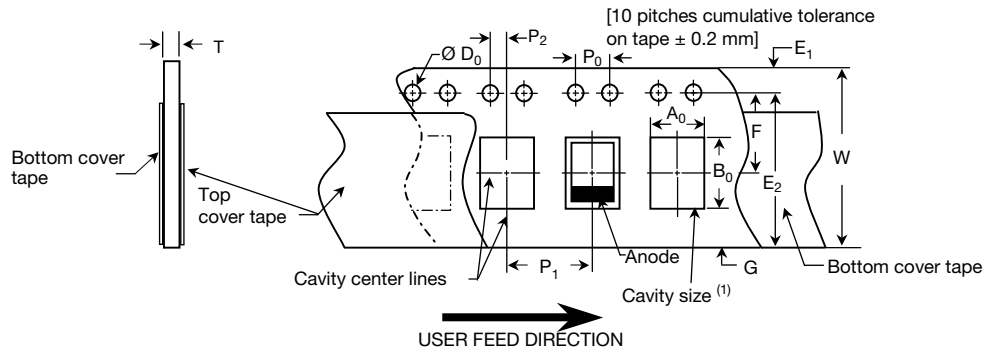
MECHANICAL PERFORMANCE CHARACTERISTICS		
ITEM	CONDITION	POST TEST PERFORMANCE
Terminal Strength	Apply a pressure load of 5 N for 10 s ± 1 s horizontally to the center of capacitor side body. AEC Q-200 rev. C method 006	There shall be no visual damage when viewed at 20 x magnification and the component shall meet the original electrical requirements.
Vibration	MIL-STD-202, method 204D, 10 Hz to 2000 Hz, 20 g peak	Capacitance change ± 10 % Dissipation factor Initial specified value or less Leakage current Initial specified value or less ESR Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning.
Shock	MIL-STD-202, method 213B, condition I, 100 g peak	Capacitance change ± 10 % Dissipation factor Initial specified value or less Leakage current Initial specified value or less ESR Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning.
Resistance to Solder Heat	MIL-STD-202, method 210F, condition K	Capacitance change ± 30 % Dissipation factor Not to exceed 150 % of initial Leakage current Not to exceed 200 % of initial There shall be no mechanical or visual damage to capacitors post-conditioning.
Solderability	MIL-STD-202, method 208H, ANSI/J-STD-002, Test B. Applies only to solder and tin plated terminations. Does not apply to gold terminations.	All terminations shall exhibit a continuous solder coating free from defects for a minimum of 95 % of the critical area of any individual lead.
Resistance to Solvents	MIL-STD-202, method 215D	Marking has to remain legible, no degradation of encapsulation material.
Flammability	Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %	

PLASTIC TAPE AND REEL PACKAGING in inches [millimeters]

Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- (1) A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossement. Dimensions of embossement location shall be applied independent of each other.
- (6) B₁ dimension is a reference dimension tape feeder clearance only.

CARRIER TAPE DIMENSIONS in inches [millimeters]

CASE CODE	TAPE SIZE	B ₁ (MAX.)	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	W
P, R	8 mm	0.108 [2.75]	0.039 [1.0]	0.138 ± 0.002 [3.5 ± 0.05]	0.054 [1.37]	0.157 ± 0.004 [4.0 ± 1.0]	0.315 + 0.0118/- 0.0039 [8.0 + 0.30/- 0.10]
Q, A	8 mm	0.165 [4.2]	0.039 [1.0]	0.138 ± 0.002 [3.5 ± 0.05]	0.094 [2.4]	0.157 ± 0.004 [4.0 ± 1.0]	0.315 ± 0.012 [8.0 ± 0.30]

PAPER TAPE AND REEL PACKAGING in inches [millimeters]


CASE SIZE	TAPE SIZE	A ₀	B ₀	D ₀	P ₀	P ₁	P ₂	E	F	W	T
M	8 mm	0.041 ± 0.002 [1.05 ± 0.05]	0.071 ± 0.002 [1.8 ± 0.05]	0.06 ± 0.004 [1.5 ± 0.1]	0.157 ± 0.004 [4.0 ± 0.1]	0.157 ± 0.004 [4.0 ± 0.1]	0.079 ± 0.002 [2.0 ± 0.05]	0.069 ± 0.004 [1.75 ± 0.1]	0.0138 ± 0.002 [3.5 ± 0.05]	0.315 ± 0.008 [8.0 ± 0.2]	0.037 ± 0.002 [0.95 ± 0.05]

Note

- (1) A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.

STANDARD PACKAGING QUANTITY

CASE CODE	QUANTITY (PCS/REEL)
	7" REEL
M	4000
R	2500
P	3000
Q	2500
A	2000

RECOMMENDED VOLTAGE DERATING GUIDELINES
STANDARD CONDITIONS. FOR EXAMPLE: OUTPUT FILTERS

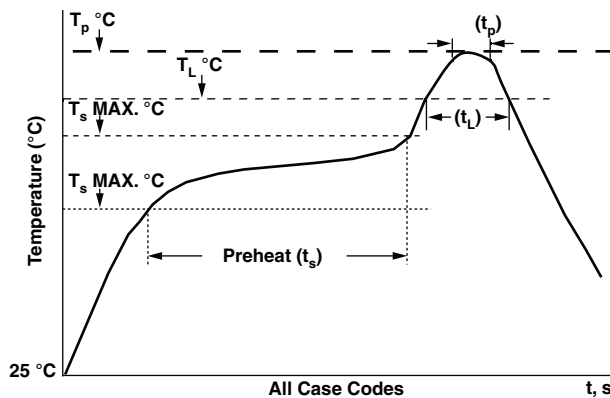
Capacitor Voltage Rating	Operating Voltage
4.0	2.5
6.3	3.6
10	6.0
16	10
20	12
25	15
35	24
50	28

SEVERE CONDITIONS. FOR EXAMPLE: INPUT FILTERS

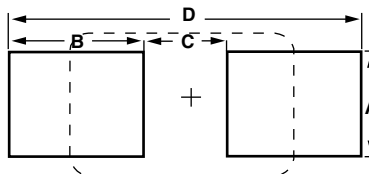
Capacitor Voltage Rating	Operating Voltage
4.0	2.5
6.3	3.3
10	5.0
16	8.0
20	10
25	12
35	15
50	24

POWER DISSIPATION

CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT + 25 °C (W) IN FREE AIR
M	0.025
R	0.045
P	0.045
Q	0.055
A	0.075

RECOMMENDED REFLOW PROFILES


T_P lead (Pb)-free	T_P Sn/Pb	t_p	T_L lead (Pb)-free	T_L Sn/Pb	T_S MIN. lead (Pb)-free	T_S MIN. Sn/Pb	T_S MAX. lead (Pb)-free	t_s MAX. Sn/Pb	t_s lead (Pb)-free	T_S Sn/Pb	t_L
260 °C	225 °C	10	217 °C	183 °C	150 °C	100 °C	200 °C	150 °C	60 to 150	60 to 90	60

PAD DIMENSIONS in inches [millimeters]


CASE CODE	A (MIN.)	B (NOM.)	C (NOM.)	D (NOM.)
M	0.039 [1.00]	0.028 [0.70]	0.024 [0.60]	0.080 [2.00]
R	0.059 [1.50]	0.031 [0.80]	0.039 [1.0]	0.102 [2.60]
P	0.063 [1.60]	0.031 [0.80]	0.047 [1.20]	0.110 [2.80]
Q	0.071 [1.80]	0.067 [1.70]	0.053 [1.35]	0.187 [4.75]
A	0.071 [1.80]	0.067 [1.70]	0.053 [1.35]	0.187 [4.75]

GUIDE TO APPLICATION

1. **AC Ripple Current:** The maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

2. **AC Ripple Voltage:** The maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

Z = The capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at + 25 °C.
3. **Reverse Voltage:** These capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at + 25 °C, 5 % of the DC rating at + 85 °C and 1 % of the DC rating at + 125 °C.
4. **Temperature Derating:** If these capacitors are to be operated at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+ 25 °C	1.0
+ 85 °C	0.9
+ 125 °C	0.4

5. **Power Dissipation:** Power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using + 25 °C temperature rise.)

6. **Printed Circuit Board Materials:** Molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelainized steel).

7. **Attachment:**

- 7.1 **Solder Paste:** The recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.

- 7.2 **Soldering:** Capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time/temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.

- 7.2.1 **Backward and Forward Compatibility:** Capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.

8. **Cleaning (Flux Removal) After Soldering:** Molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chloroethane, Terpene and aqueous cleaning media. However, CFC/ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.

- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. Do not exceed 9W/l at 40 kHz for 2 min.

9. **Recommended Mounting Pad Geometries:** Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and/or circuit board design.

PRODUCT INFORMATION	
Micro Guide	www.vishay.com/doc?40115
Moisture Sensitivity	www.vishay.com/doc?40135
SELECTOR GUIDES	
Solid Tantalum Selector Guide	www.vishay.com/doc?49053
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Frequently Asked Questions	www.vishay.com/doc?40110



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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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